

# 101454C

FB600-87 600 MHz Bandpass Filter 87 MHz Bandwidth

## Specifications

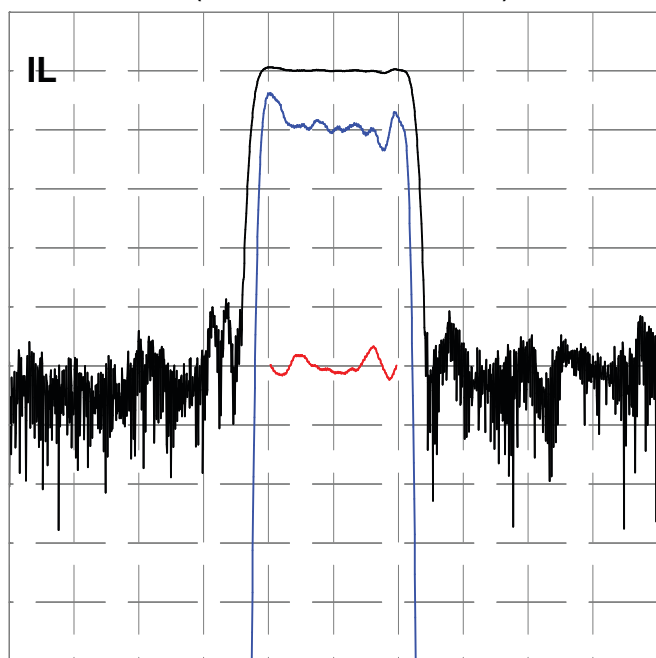
Parameter	Symbol	Min	Typical	Max	Unit
Center Frequency	$F_0$		600		MHz
Bandwidth	B		87		MHz
-3dB Bandwidth	$B_3$	95.4	95.8		MHz
-40dB Bandwidth	$B_{40}$		112.1	113.5	MHz
Delay	$T_0$	0.77	0.773	0.775	$\mu$ sec
Insertion Loss	IL		33.5	34	dB
Amplitude Ripple			0.9	1.4	dB <sub>P-P</sub>
Phase Ripple			5.8	8	deg <sub>P-P</sub>
Rejection		37	41		dB
Spurious for $ t - T_0  > .9T_0$			-52	-42	dB
Substrate Material		X112Y-LT			

### Notes

- Center Frequency ( $F_0$ ) and Bandwidth (B) are defined, not measured.
- Insertion Loss is the minimum loss for  $|f - F_0| < .5B$
- Ripple spec applies to the  $|f - F_0| < .4B$ , and is doubled for  $.4B < |f - F_0| < .5B$
- Rejection spec applies to  $(B_{40} \text{ Spec} - B / 2) < |f - F_0| < F_0 / 2$
- Specifications are at 22 °C only. Unit will operate undamaged from -54 °C to 125 °C with shifts  $dF_0 = -x * F_0$ ,  $dT_0 = x * T_0$ , where  $x = 18E-6 * (\text{temperature} - 22 \text{ °C})$

## Typical Performance

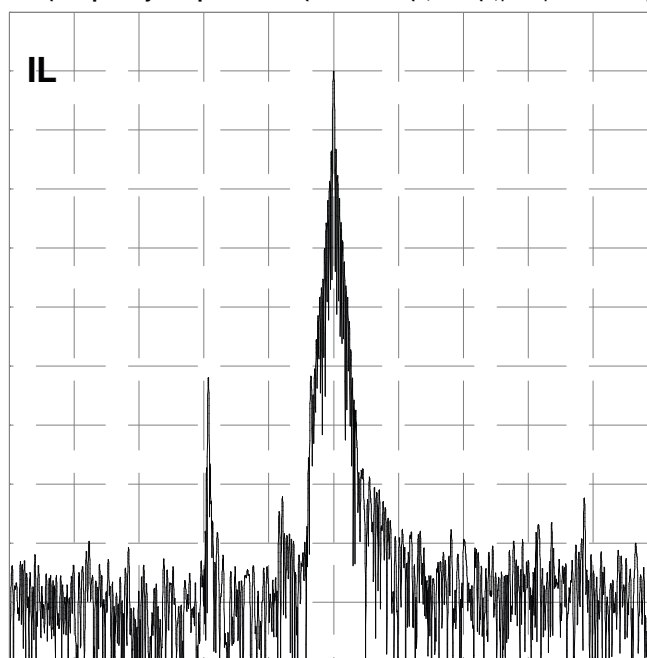
**Frequency Response**  
(Best Fit Linear Phase Removed)



10 dB/div, 1 dB/div, 10 deg/div, 40.000 MHz/div

**Impulse Response**

FFT(Frequency Response \* Cos(0.5\*PI\*MIN(1,MAX(0,|f-F0|\*2.0/87-1.0))))^2

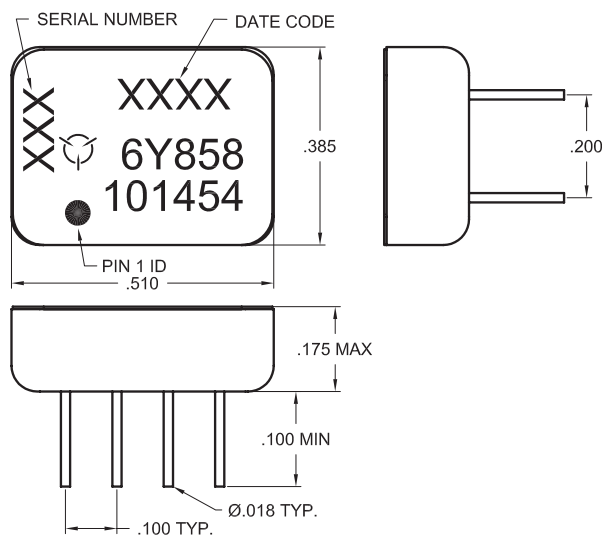


10 dB/div, 0.400 us/div

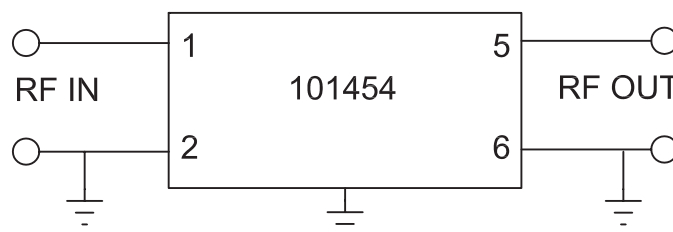
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## Package Outline



## Matching



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